

FFPF20U60DN

Features

- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- · General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- Power switching circuits





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	20	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	120	А
T _{J,} T _{STG}	Operating Junction and StorageTemperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units	
Reac	Maximum Thermal Resistance, Junction to Case	1.25	°C/W	

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage		12 17		W W	V
	I _F = 20A I _F = 20A	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	ELV		2.2 2.0	
I _{RM} *	Maximum Instantaneous Reverse Current @ rated V _R	T _C = 25 °C T _C = 100 °C			10 100	μА
t _{rr} I _{rr} Q _{rr}	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F =20A, di/dt = 200A/μs)				90 8 360	ns A nC
W _{AVL}	Avalanche Energy		1.0			mJ

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%



Typical Characteristics

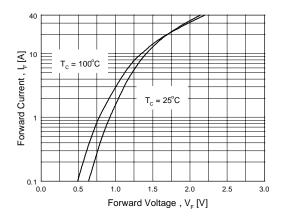


Figure 1. Typical Forward Voltage Drop vs. Forward Current

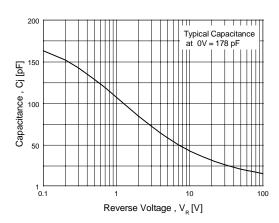


Figure 3. Typical Junction Capacitance

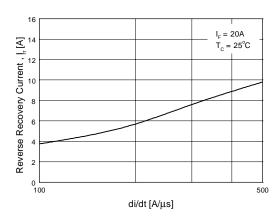


Figure 5. Typical Reverse Recovery Current vs. di/dt

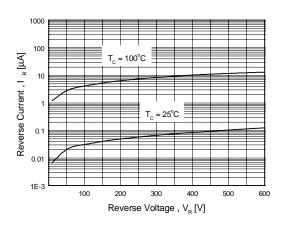


Figure 2. Typical Reverse Current vs. Reverse Voltage

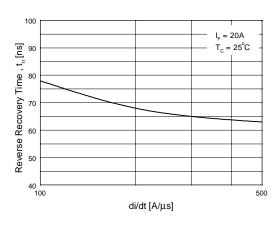


Figure 4. Typical Reverse Recovery Time vs. di/dt

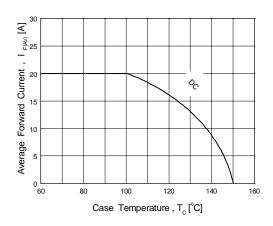
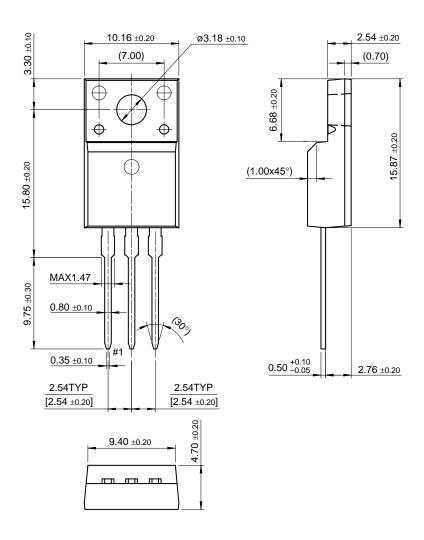


Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-220F



Dimensions in Millimeters

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